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Hilton Phoenix / Mesa Hotel Mesa, Arizona

Archive

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Session 5B Presentation 2

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Translating Specs - PCB Materials & Specifications

Pushing the limits: Variability in RF Measurements

Gert Hohenwarter GateWave Northern, Inc.





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Translating Specs - PCB Materials & Specifications

Problems

- Return loss demands are increasing due to PAM-4 and -8 modulation
- Insertion loss -1dB limit value is often crossed 'gently'
- Upper frequency limits are increasing
- Incomplete communication about life in the fast (RF) lane



Pushing the limits: Variability in RF Measurements



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Objective and Approach

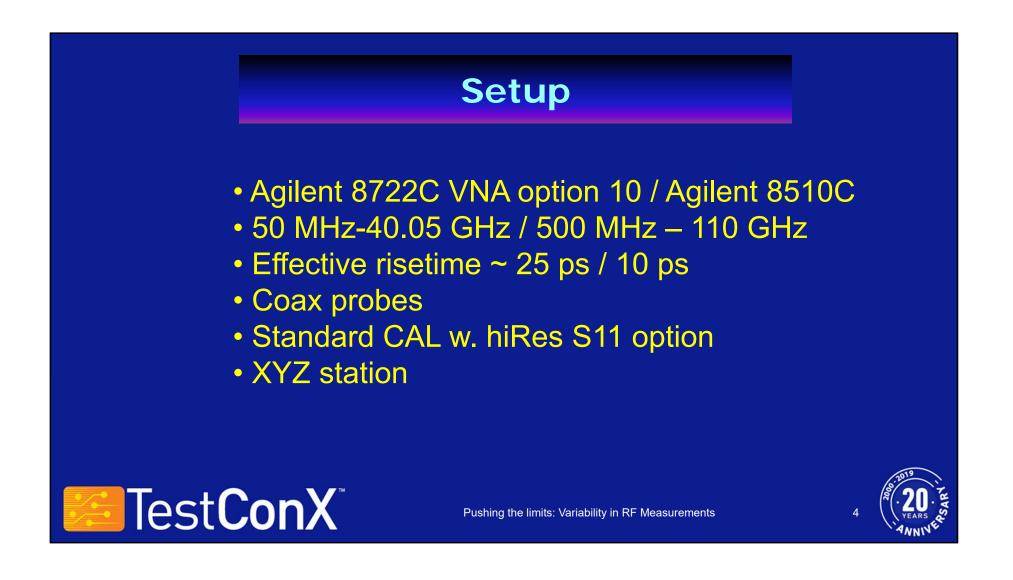
- Identify difficulties in achieving high accuracy measurements
- Examine variability
 - instrumentation error
 - repeated device insertions without any other changes
 - repeated 'from scratch' measurements
 - sensitivity to positioning error
- Highlight sensitivity in low return loss S11 cases (<-30dB)
- Develop understanding of underlying issues
- Measured data except where noted

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Pushing the limits: Variability in RF Measurements

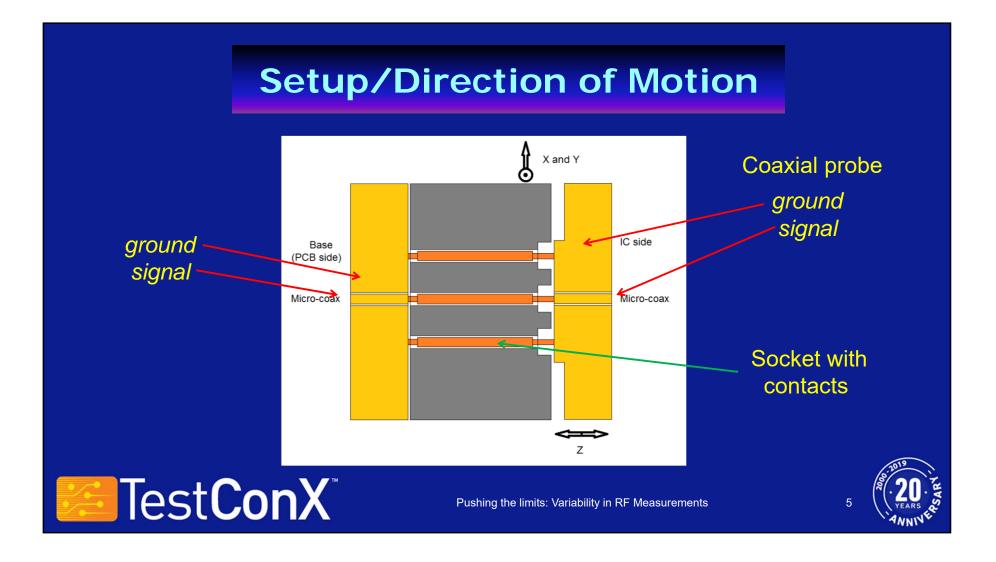


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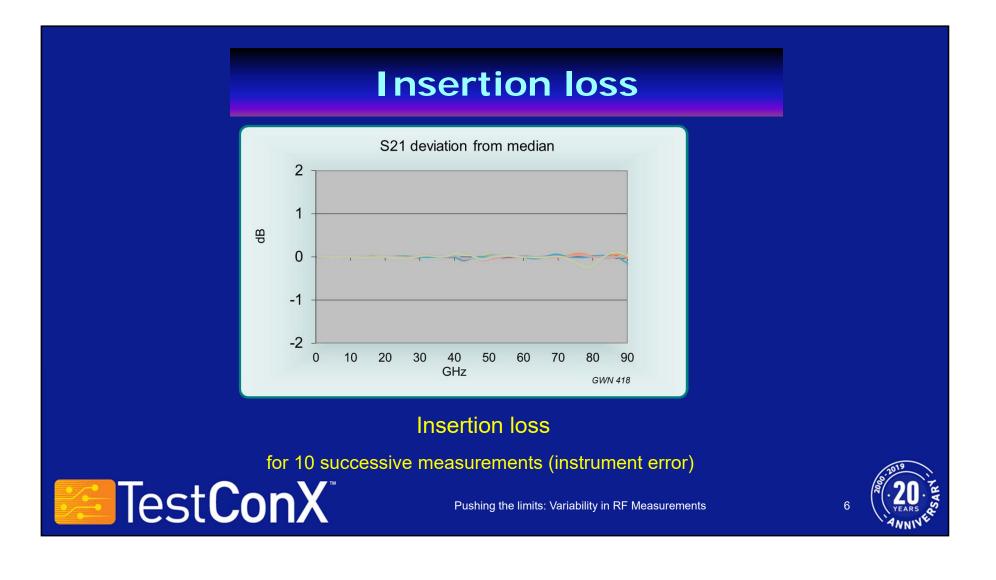
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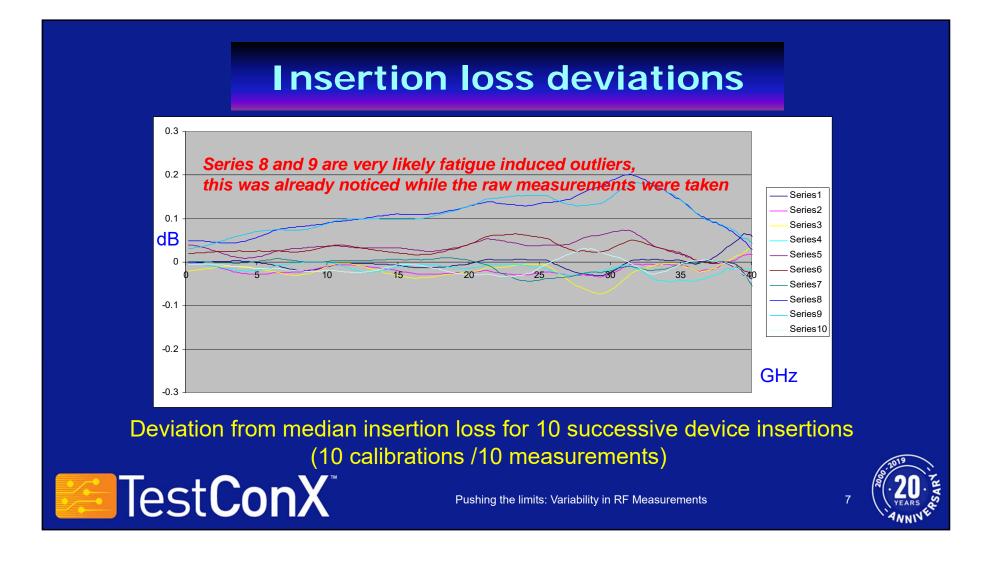


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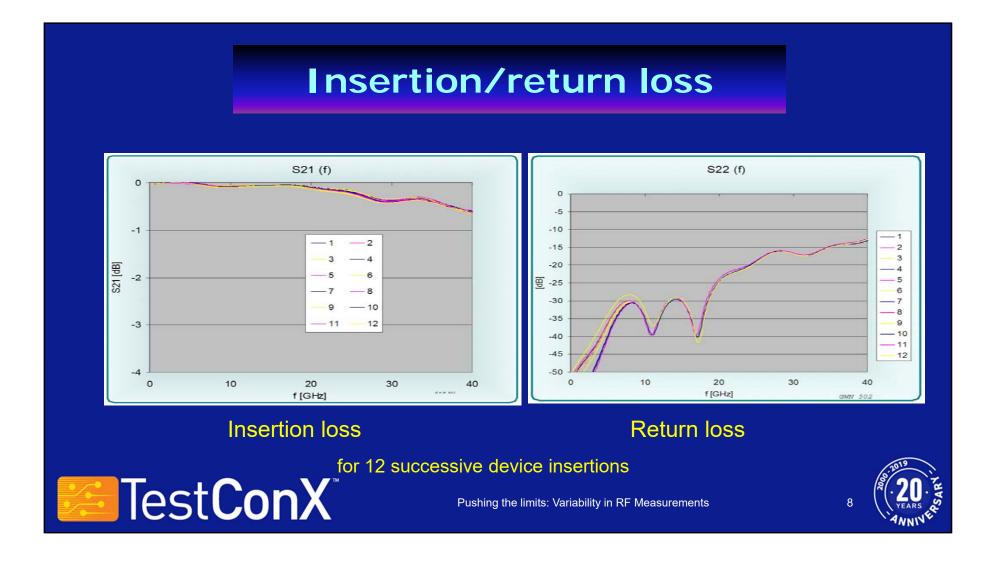
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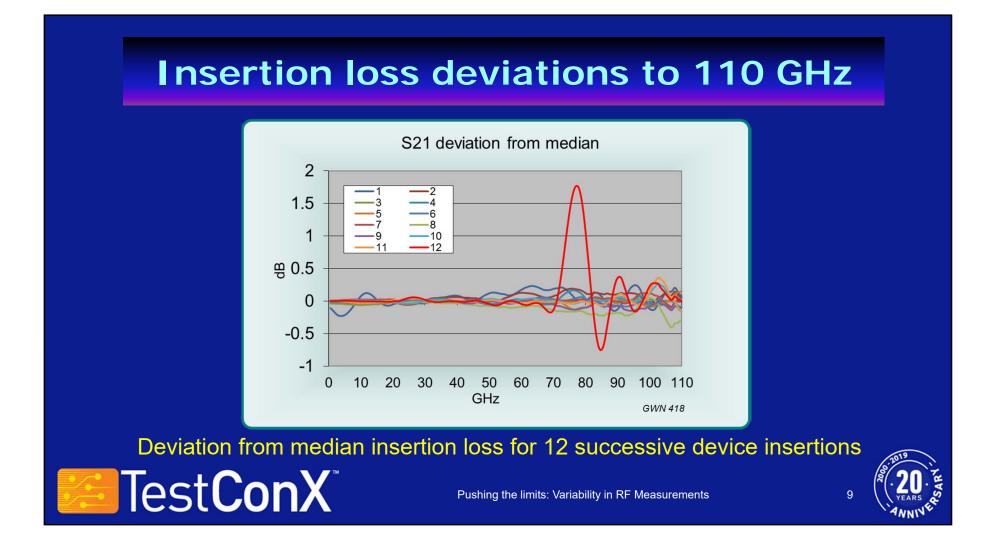


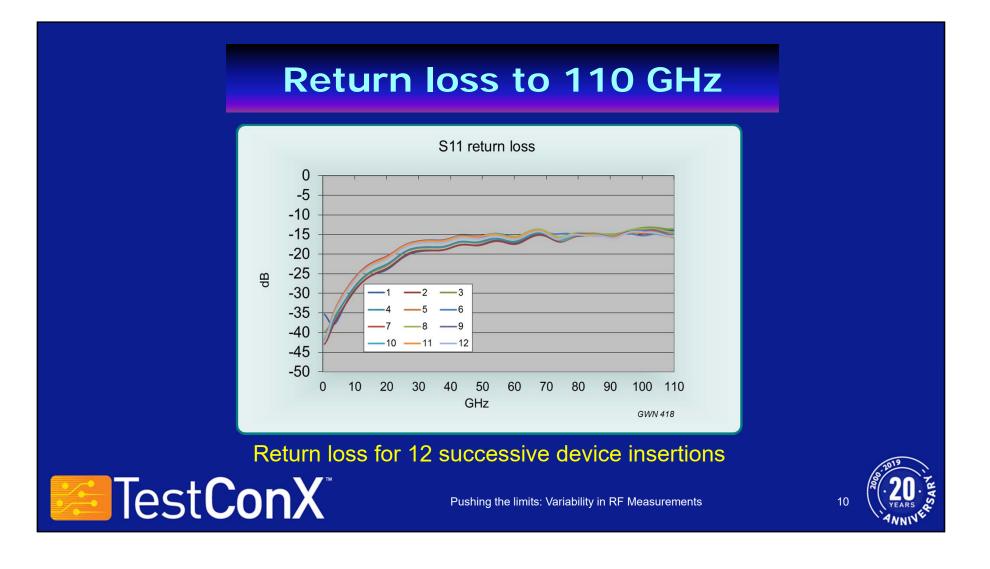
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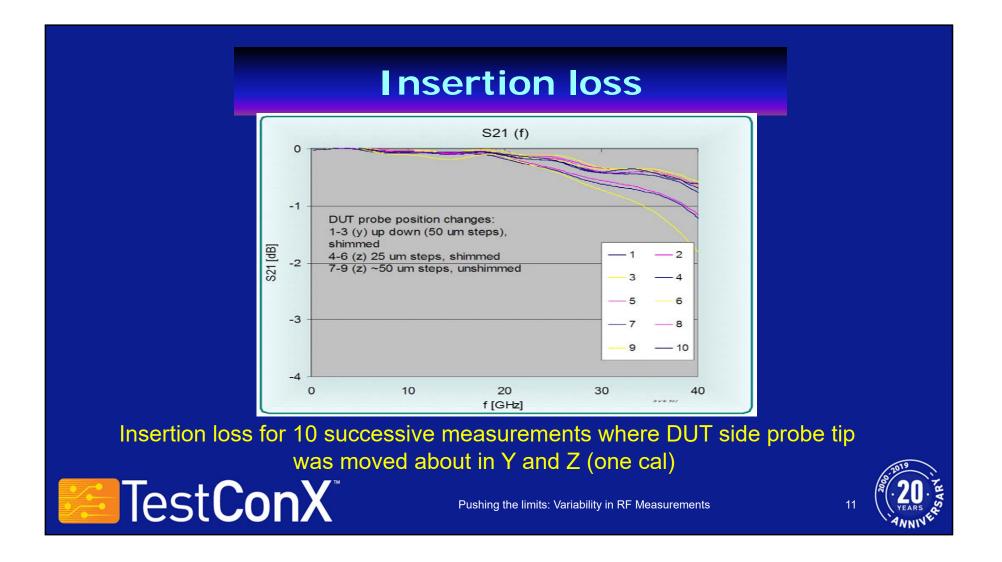
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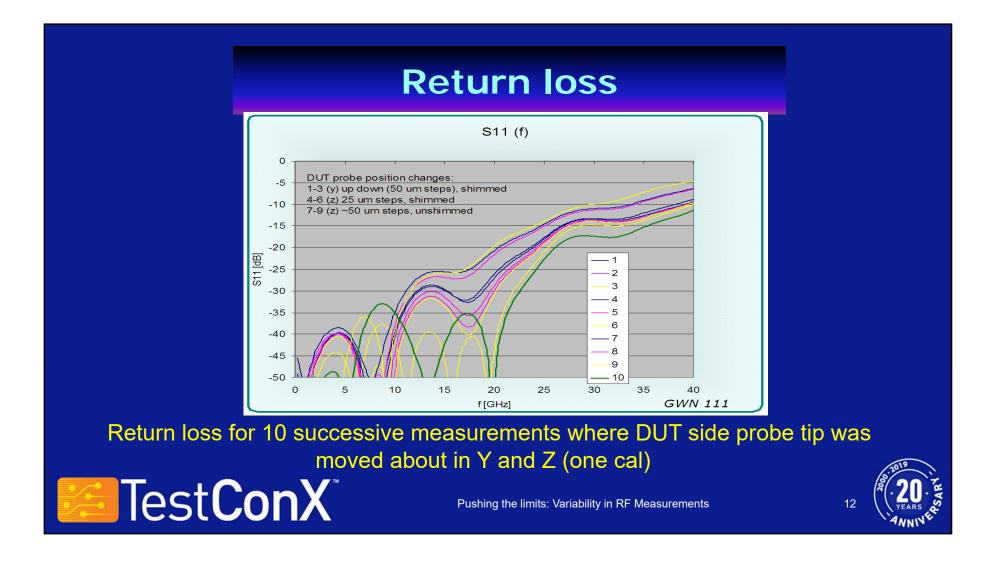


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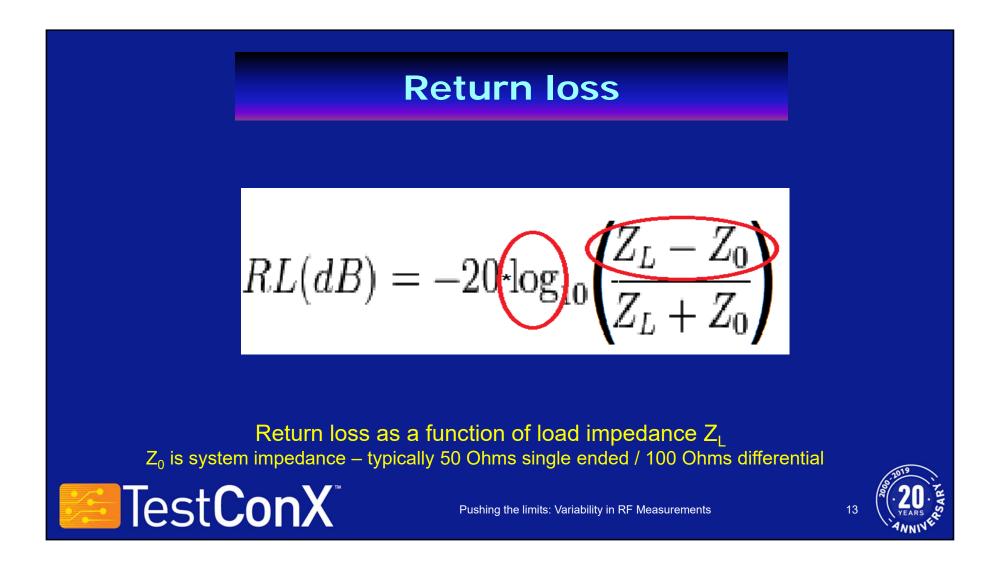
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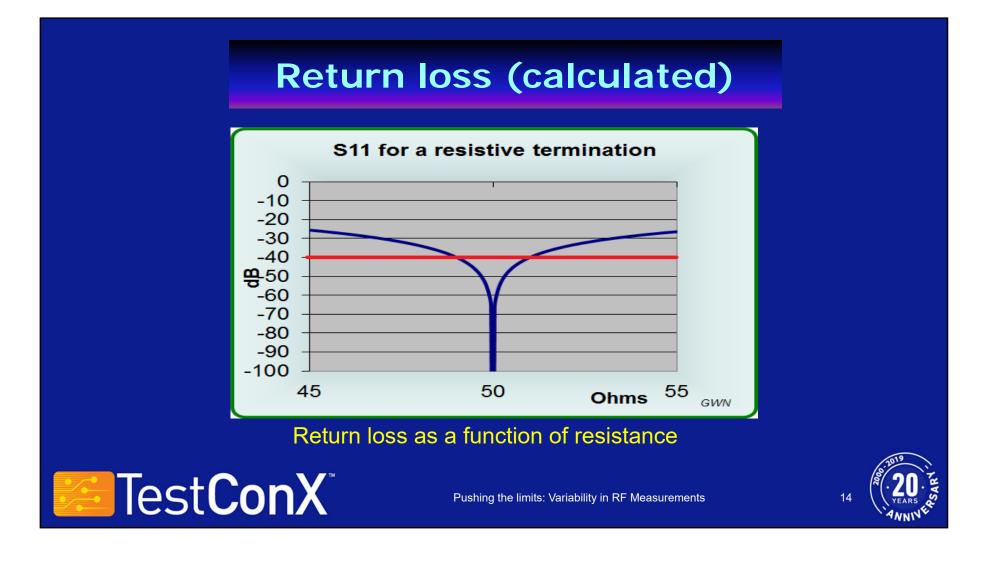


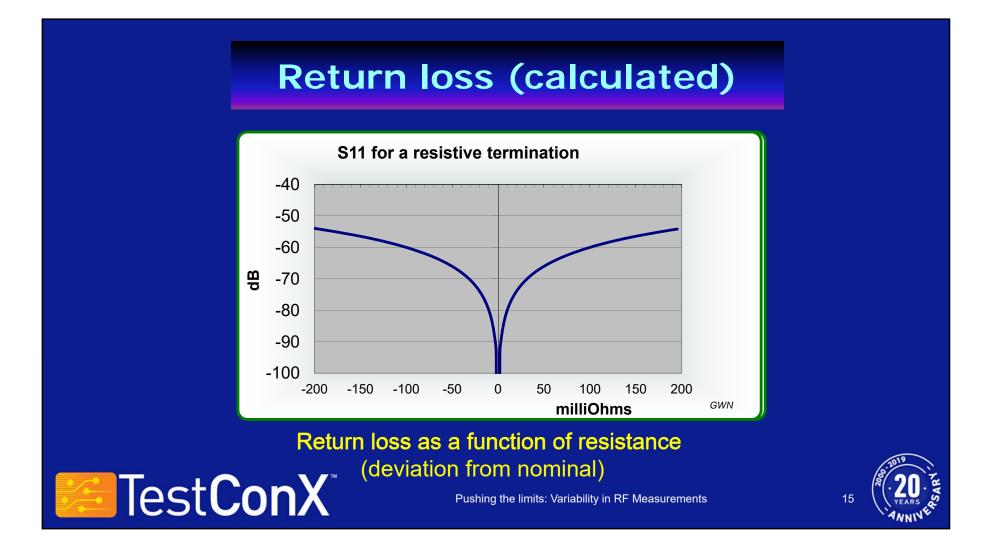
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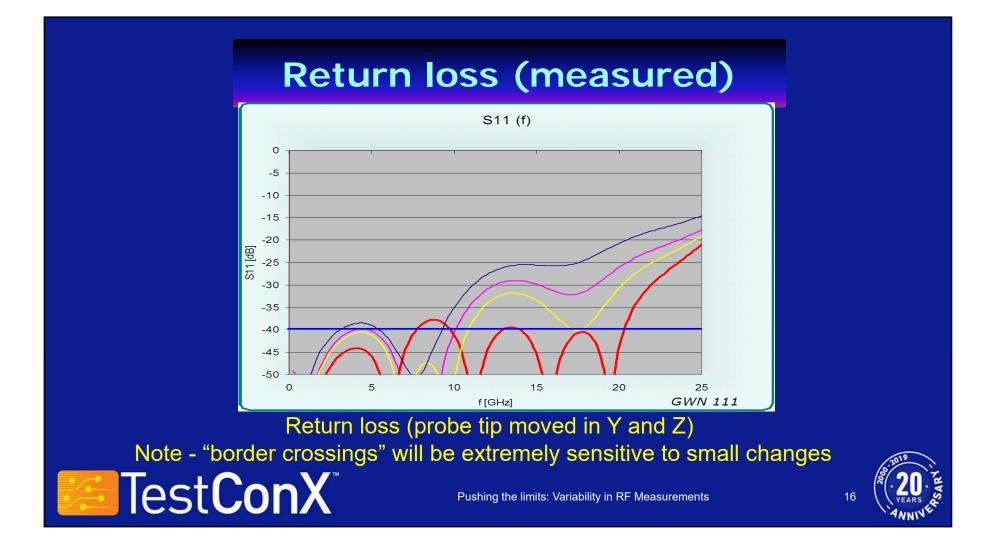


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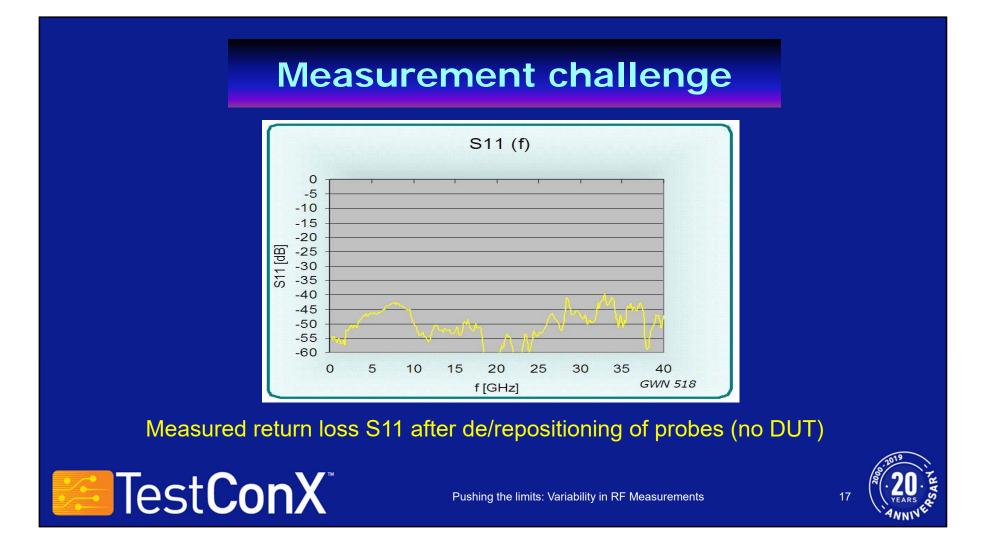


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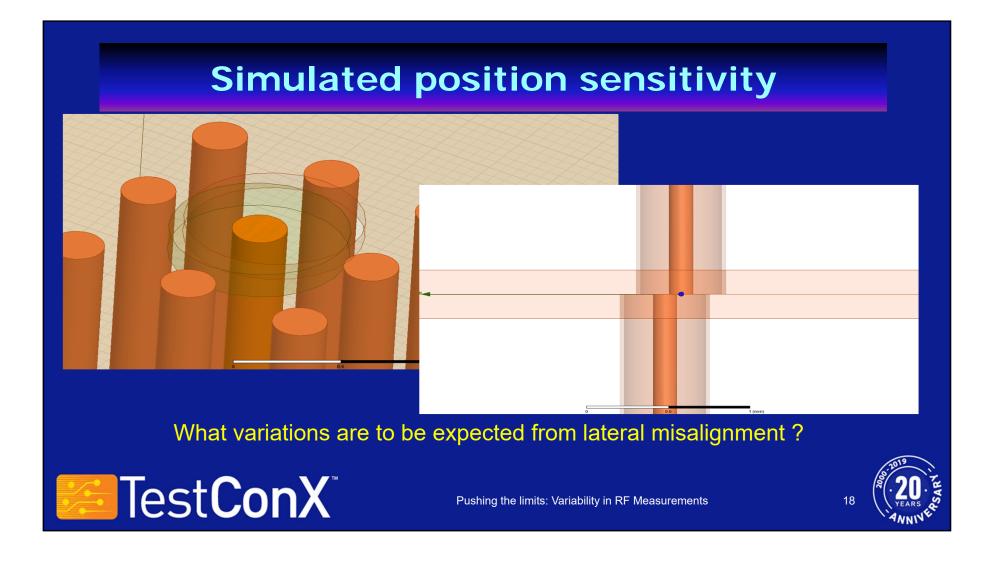
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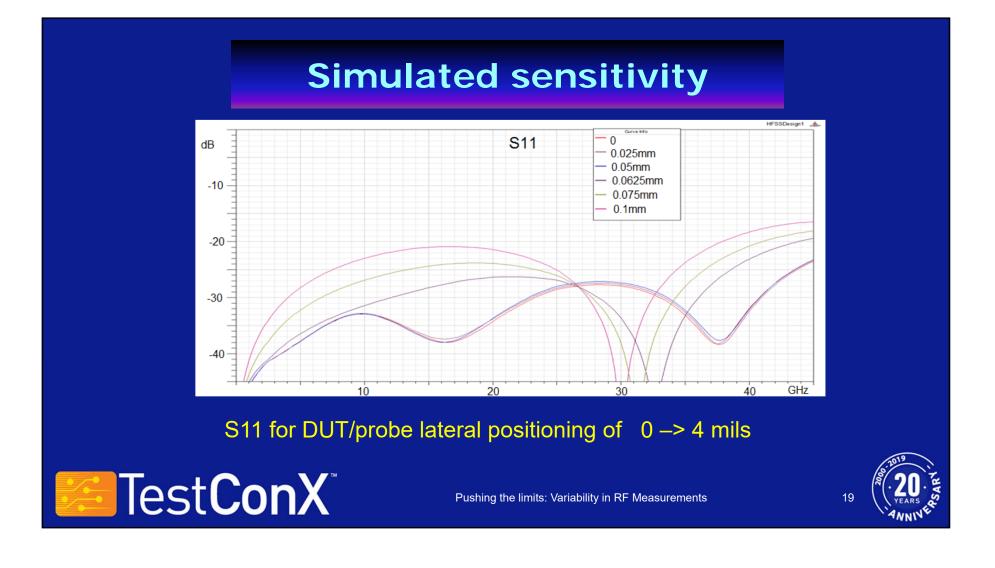
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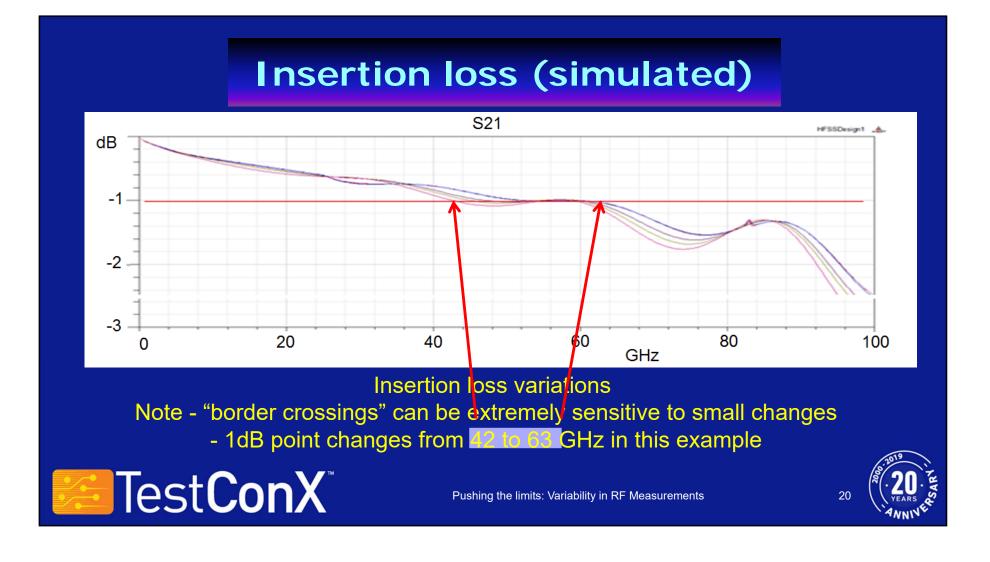


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Summary

Variability is typically low from insertion to insertion as long as return loss is in a "normal" range, i.e. between 0 and -30 dB

Return loss strongly depends on Cres for connections that have close to 50 Ohms characteristic impedance and optimal interfaces

For low values of return loss a strong DUT side probe position dependence may be observed (some positions chosen may be outside the normal test tolerance)

Insertion loss can be adversely affected by improper DUT probe position as well Pushing the limits: Variability in RF Measurements 21

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